



## Material Content Data Sheet



<b>Sales Product Name</b>		IPL65R1K0C6S		<b>Issued</b>		19. July 2018		
<b>MA#</b>		MA001230238						
<b>Package</b>		PG-TSON-8-2		<b>Weight*</b>		92.29 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	2.509	2.72	2.72	27189	27189
leadframe	inorganic material	phosphorus	7723-14-0	0.010	0.01		111	
	non noble metal	zinc	7440-66-6	0.041	0.04		443	
	non noble metal	iron	7439-89-6	0.818	0.89		8864	
wire	non noble metal	copper	7440-50-8	33.217	35.99	36.93	359923	369341
	non noble metal	copper	7440-50-8	0.399	0.43	0.43	4323	4323
	encapsulation	organic material	carbon black	1333-86-4	0.103	0.11		1115
plastics	plastics	epoxy resin	-	5.301	5.74		57444	
	inorganic material	silicondioxide	60676-86-0	46.065	49.92	55.77	499145	557704
leadfinish	non noble metal	tin	7440-31-5	1.053	1.14	1.14	11412	11412
plating	noble metal	silver	7440-22-4	0.209	0.23	0.23	2261	2261
solder	noble metal	silver	7440-22-4	0.064	0.07		694	
	non noble metal	tin	7440-31-5	0.051	0.06		555	
	non noble metal	lead	7439-92-1	2.448	2.65	2.78	26521	27770
*deviation	< 10%				Sum in total:	100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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